

STTH112

High voltage ultrafast rectifier

Features

- Low forwarded voltage drop
- High reliability
- High surge current capability
- Soft switching for reduced EMI disturbances
- Planar technology

Description

The STTH112, which is using ST ultrafast high voltage planar technology, is specially suited for free-wheeling, clamping, snubbering, demagnetization in power supplies and other power switching applications

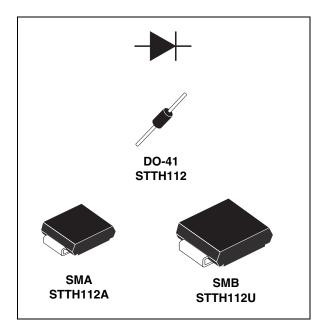


Table 1. Device summary

Symbol	Value
I _{F(AV)}	1 A
V _{RRM}	1200 V
T _{j (max)}	175 °C
V _{F (max)}	1.65 V

1 Electrical characteristics

Absolute ratings (limiting values)

Symbol	Parameter		Value	Unit		
V _{RRM}	Repetitive peak reverse voltage				1200	V
V _(RMS)	Voltage rms				850	V
		TI = 85°C	δ =0.5	DO-41		
I _{F(AV)}	Average forward current	TI = 115°C	δ =0.5	SMA	1	А
	TI = 125°C δ =0.5				1	1
				DO-41	20	
I _{FSM}	I _{FSM} Forward surge current t = 8.3 ms			SMA	10	А
				SMB	18	
T _{stg}	Storage temperature range					°C
Тj	Maximum operating junction temperature				+ 175	°C

Table 2.Thermal parameters

Symbol	Parameter			Value	Unit
		L = 10 mm	DO-41	45	
R _{th (j-l)}	Junction to lead		SMA	30	°C/W
			SMB	25	0/00
R _{th (j-a)}	Junction to ambient	L = 10 mm	DO-41	110	

Table 3. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
	Reverse leakage current	V _R = 1200 V	T _j = 25 °C			5	μA
I R	everse leakage current $V_{\rm R} = 1200$ V	v _R = 1200 v	T _j = 125 °C			50	μΑ
			T _j = 25 °C			1.9	
V _F Fo	Forward voltage drop	I _F = 1 A	T _j = 125 °C		1.17	1.65	V
			T _j = 150 °C		1.10	1.55	

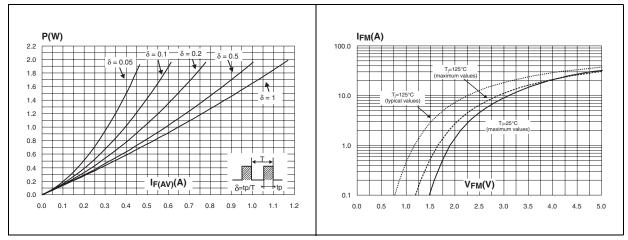
Table 4. Dynamic electrical characteristics

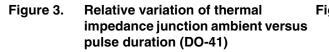
Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
t _{rr}	Reverse recovery time	I _F = 0.5 A I _{rr} = 0.25 A I _R = 1A	T _j = 25 °C			75	ns
t _{fr}		$I_F = 1 A$	T 05 00			500	ns
V _{FP}		dl _F /dt = 50 A/µs V _{FR} = 1.1 x V _{Fmax}	T _j = 25 °C			30	V

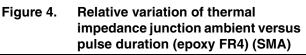


Figure 1. Conduction losses versus average Figure 2. current









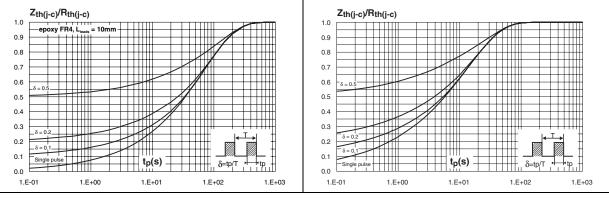


Figure 5. Relative variation of thermal impedance junction ambient versus pulse duration (epoxy FR4)(SMB)

Figure 6. Thermal resistance junction to ambient versus copper surface under each lead (DO-41, SMB)

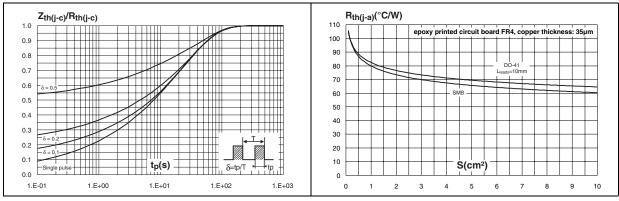


Figure 7. Thermal resistance junction to ambient versus copper surface under each lead (epoxy printed circuit board FR4, copper thickness: 35µm) (SMA)

	R _{th(j-a)} (°C/W)
140	
130	
120	
110	
100	
90	
80	
70	
60	
50	
40	
30	
20	
10	D S(cm ²)
(
	0.0 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0



2 Package information

- Epoxy meets UL 94, V0
- Band indicates cathode
- Bending method (DO-41): see Application note AN1471

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 5. SMA dimensions

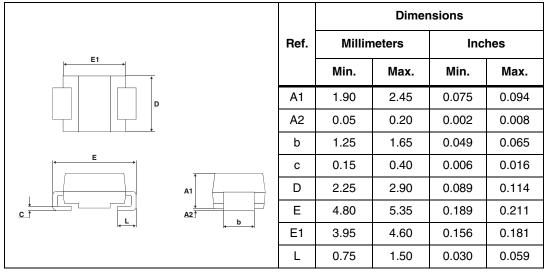


Figure 8. Footprint (dimensions in mm)

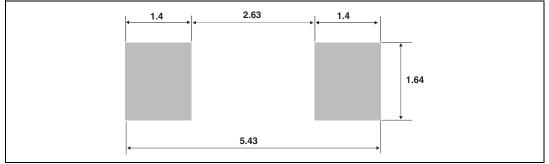


Table 6.SMB dimensions

			Dimensions				
		Ref.	Millimeters		Inches		
			Min.	Max.	Min.	Max.	
	A1	1.90	2.45	0.075	0.096		
		A2	0.05	0.20	0.002	0.008	
		b	1.95	2.20	0.077	0.087	
E E	•	с	0.15	0.40	0.006	0.016	
	A1	D	3.30	3.95	0.130	0.156	
		Е	5.10	5.60	0.201	0.220	
	l ∢ ≽l	E1	4.05	4.60	0.159	0.181	
		L	0.75	1.50	0.030	0.059	

Figure 9. Footprint (dimensions in mm)

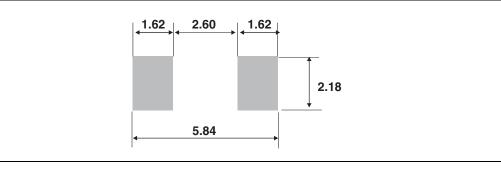
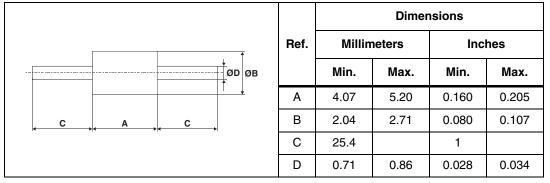


Table 7. DO-41 (plastic) dimensions



3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery Mode
STTH112	STTH112	DO-41	0.34 g	2000	Ammopack
STTH112A	H12	SMA	0.068 g	5000	Tape and reel
STTH112U	U12	SMB	0.11 g	2500	Tape and reel
STTH112RL	STTH112	DO-41	0.34 g	5000	Tape and reel

4 Revision history

Date	Revision	Changes
Jan-2003	2	Initial release.
22-Jun-2005	3	New value of $T_j = 150$ °C added to table 2. Dimensions A1 E and D updated in Table 4. Data sheet reformatted. No other technical changes.
20-Mar-2007	4	Reformatted to current standards. Updated dimensions and footprints for SMA and SMB packages.
30-Sep-2009	5	Updated table 7 package dimensions.

Table 9.Document revision history



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